

# DSGN C4601: Microelectronic Design 1

Module Title	:	Microelectronic Design 1		
Language o	f Instruction:	English		
Credits:	10			
NFQ Level:	8			
Module Deli	vered In	2 programme(s)		
Teaching & Strategies:	Learning	Teaching will take the form of problem-based learning during tutorials and practical classes. An emphasis will be placed on relating individual circuits and devices to useful practical applications both in theory and practical classes. Circuit simulation software will be used extensively in the problem-solving sessions to validate students' solutions.		
Module Aim	:	To provide: (a) Detailed analyses of semiconductor devices and their CAD models. (b) Knowledge of circuit- level simulation and layout tools. (c) Methodologies for digital and analogue IC analysis and design.		
Learning Ou	itcomes			
On successf	ul completion o	this module the learner should be able to:		
LO1	Carry out a va	riety of simulations using a modern circuit simulator.		
LO2	Derive and ut	ise semiconductor device models in circuit design simulations.		
LO3	Layout and ve	rify integrated circuit designs.		
LO4	Design and a	alyse integrated amplifier circuits and cascodes.		
LO5	Design and a	alyse current mirrors & reference circuits.		
LO6	Design and a	alyse differential amplifiers.		
Pre-requisite learning				
Module Recommendations This is prior learning (or a practical skill) that is recommended before enrolment in this module.				
No recommendations listed				
Incompatible Modules These are modules which have learning outcomes that are too similar to the learning outcomes of this module.				
No incompat	ible modules lis	ed		
Co-requisite	Modules			
No Co-requis	site modules lis	ed		
<b>Requiremen</b> This is prior l	n <b>ts</b> learning (or a pl	actical skill) that is mandatory before enrolment in this module is allowed.		
Students sho	ould have comp	eted a module equivalent to the following from CW527: Analysis of Analogue Circuits (yr3).		



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## **Module Content & Assessment**

## Indicative Content

### 1. Circuit Simulation & Layout

SPICE Device Elements; Semiconductor Devices; Analysis Modes and Techniques; Full-Custom IC Layout.

2. Semiconductor Fabrication Wafer Preparation and Mask-making; Layering, Patterning and Doping; Electrical Tests and Die Packaging.

3. Semiconductor Device Modelling Semiconductor Materials and their Properties; PN Junction and BJT Modelling; MOSFET Modelling; Amplifier Configurations.

### 4. Amplifier & Cascode Configurations

BJT & MOS integrated amplifiers; Cascoded transconductors and loads.

### 5. Current Mirrors & References

MOS and bipolar Current Mirroring; Temperature and Sensitivity Analysis; Voltage and Current Referencing.

### 6. Differential Amplifiers

Qualitative Analysis and Bipolar/MOSFET Differences; Small-Signal and Large-Signal Analysis; Cascode Differential Amplifiers; Common-Mode Rejection; Use of Active Loads.

Assessment Breakdown	%
Continuous Assessment	20.00%
Practical	20.00%
End of Module Formal Examination	60.00%

Continuous Assessr	nent			
Assessment Type	Assessment Description	Outcome addressed	% of total	Assessment Date
Examination	Students will sit a written examination during the module.	2,4,5,6	20.00	n/a

No Project

Practical				
Assessment Type	Assessment Description	Outcome addressed	% of total	Assessment Date
Practical/Skills Evaluation	Students will complete a series of practical assignments, under supervision, using circuit simulation software.	1,2,3,4,5,6	20.00	n/a

End of Module	Formal Examination			
Assessment Type	Assessment Description	Outcome addressed	% of total	Assessment Date
Formal Exam	A written examination, at the end of the module, will examine the extent of the student's achievement of the learning outcomes.	1,2,3,4,5,6	60.00	End-of- Semester

SETU Carlow Campus reserves the right to alter the nature and timings of assessment



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# Module Workload

Workload: Full Time		
Workload Type	Frequency	Average Weekly Learner Workload
Lecture	Every Week	4.00
Practicals	Every Week	3.00
Independent Learning Time	Every Week	3.00
	Total Hours	10.00

Module Delivered In			
Programme Code	Programme	Semester	Delivery
CW_EEBEE_B	Bachelor of Engineering (Honours) in Biomedical Electronics	7	Mandatory
CW_EESYS_B	Bachelor of Engineering (Honours) in Electronic Engineering	7	Mandatory